PATENT NUMBER **表示。特别的数据对对对** APPLICATION NO. CONT/P CONT/PRIOR ART UNIT 2817 Mariany Metallization structures for semiconductor device interconnects, methods for making same, and semiconductor devices including same devices including same

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The term of this patent shall, in or extend beyond the expiration date.	THE TOTAL PROPERTY OF THE PARTY	
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d disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 868 and contractors only

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